

Docket No.: 050103-0553

PATENT

Reply Under 37 CFR 1.116 - Expedited Procedure - Technology Center 1700

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Rajiv Yadav RANJAN, et al.

Application No.: 10/776,203

Customer No.: 49745

Filed: February 12, 2004

Confirmation No.: 2760

Group Art Unit: 1795

Examiner: McDonald, Rodney Glenn

Title: METHOD & APPARATUS FOR MULTI-STAGE SPUTTER DESPOSITION OF
UNIFORM THICKNESS LAYERS

RESPONSE TO OFFICE ACTION UNDER 37 C.F.R. § 1.116

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
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Sir:

This is in response to the Office Action dated April 24, 2009

Remarks begin on page 2 of this paper.